Release by
PARALIGHTDCC

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DATA SHEET

PART NO.:L-C295QRLGCT-BIC-5A

REV: A / 1

CUSTOMER'S APPROVAL: _____ DCC: _____

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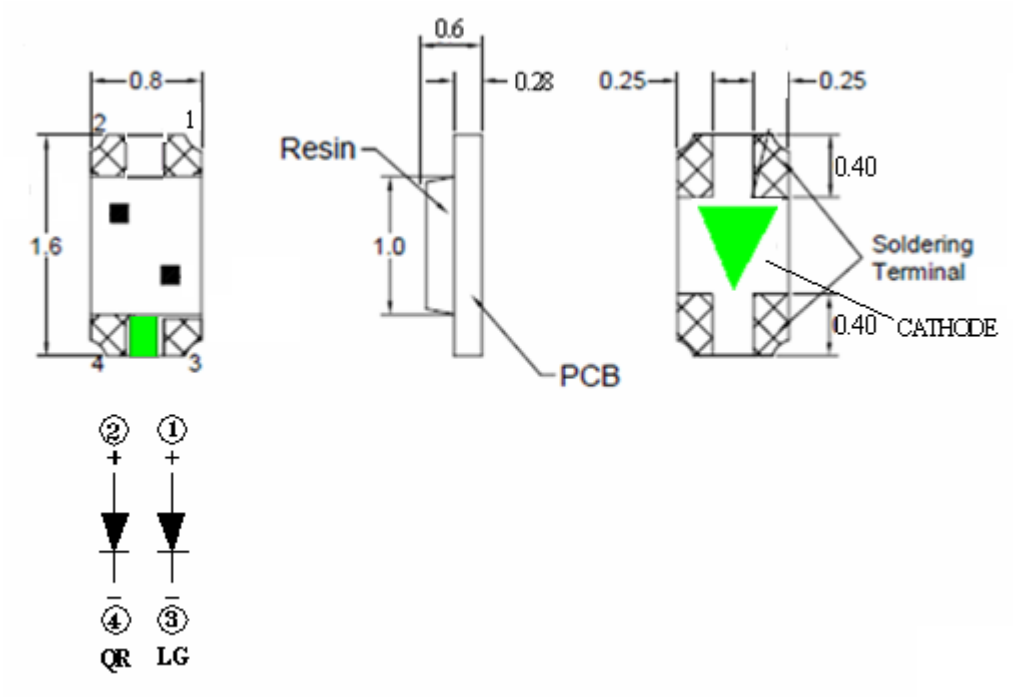
PACKAGE OUTLINE DIMENSIONS



Note：

1. All dimensions are in millimeters.
2. Tolerance is ± 0.1mm (.004") unless otherwise noted

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Features

- ✳ Dual color, top view, wide view angle Chip LED.
- ✳ Package in 8mm tape on 7" diameter reels.
- ✳ Compatible with automatic Pick & Place equipment.
- ✳ Compatible with Reflow soldering and Wave soldering processes.
- ✳ EIA STD package.
- ✳ I.C. compatible.
- ✳ Pb free product.

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Chip Materials

chip	Light Color	Dice Material	Lens Color
QR	Super Red	AlInGap	Water Clear
LG	Super Green	InGaN	

Absolute Maximum Ratings (Ta=25℃)

Symbol	Parameter	Rating		Unit
		Super Red	Super Green	
PD	Power Dissipation	60	100	mW
IPF	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	100	mA
IF	Continuous Forward Current	25	25	mA
-	De-rating Linear From 25℃	0.25	0.25	mA/℃
VR	Reverse Voltage	5	5	V
ESD	Electrostatic Discharge Threshold (HBM)Note A	2000	1000	V
Topr	Operating Temperature Range	-40 ~ +85		℃
Tstg	Storage Temperature Range	-40 ~ +85		℃
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)		℃

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

Electro-Optical Characteristics (Ta=25℃)

SYMBOL		PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
VF	Super Red	Forward Voltage	IF = 5mA		1.8	2.1	V
	Super Green				2.7	3.0	
IV	Super Red	Luminous Intensity	IF = 5mA	45	76		mcd
	Super Green			112	220		
2θ1/2		Half Intensity Angle	IF = 5mA		130		deg
λD	Super Red	Dominant Wavelength	IF = 5mA		630		nm
	Super Green				527		
λp	Super Red	Peak Emission Wavelength	IF = 5mA		636		nm
	Super Green				520		
Δλ	Super Red	Spectral Line Half-Width	IF = 5mA		17		nm
	Super Green				15		
IR	Super Red	Reverse Current	VR = 5V			10	μA
	Super Green					50	

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Bin Code List

Luminous Intensity (IV), Unit: mcd@5mA					
Super Red			Super Green		
Bin Code	Min	Max	Bin Code	Min	Max
P	45	71	R	112	180
Q	71	112	S	180	280

Tolerance of each bin are±15%

Forward Voltage(VF), Unit:V@5mA		
Super Green		
Bin Code	Bin Code	Bin Code
10	2.5	2.6
11	2.6	2.7
12	2.7	2.8
13	2.8	2.9
14	2.9	3.0

Tolerance of each bin are±0.1Volt

Dominant Wavelength (Hue), Unit: nm@5mA					
Super Red			Super Green		
Bin Code	Min	Max	Bin Code	Min	Max
R1	626	631	AP	520	525
R2	631	636	AQ	525	530
			AR	530	535

Tolerance of each bin are±1nm

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Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD:
   Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
5. Major standard testing equipment by “Instrument System” Model: CAS140B Compact Array Spectrometer and “KEITHLEY” Source Meter Model: 2400.

● Typical Electro-Optical Characteristics Curves

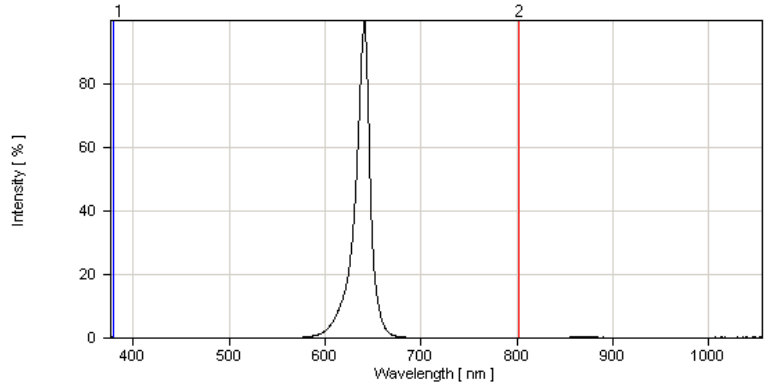

Fig.1 Super Red Relative Intensity vs. Wavelength

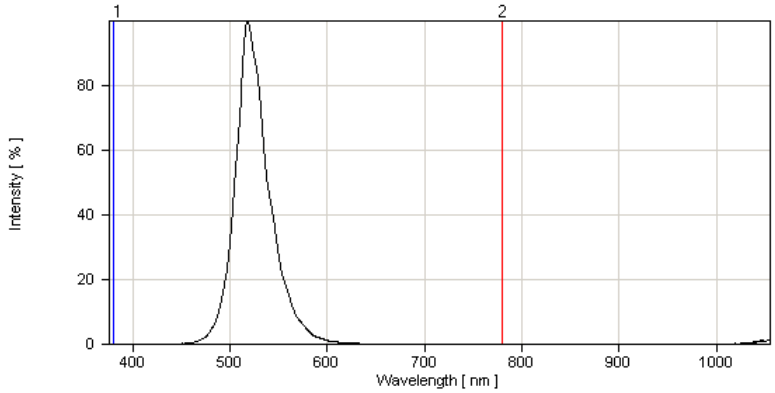

Fig.1 Super Green Relative Intensity vs. Wavelength

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Super Red Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

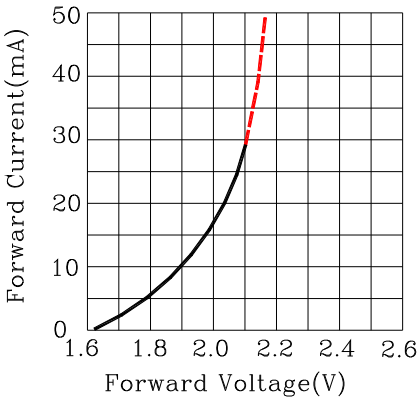

Fig.2 Forward Current vs.Forward Voltage

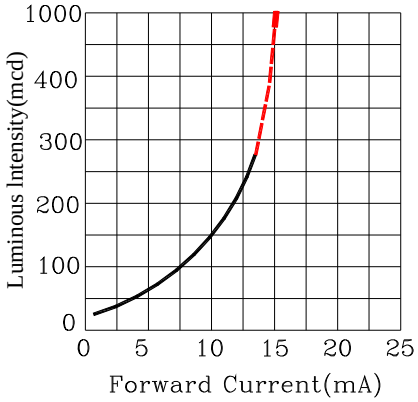

Fig.3 Luminous Intensity vs.Forward Current

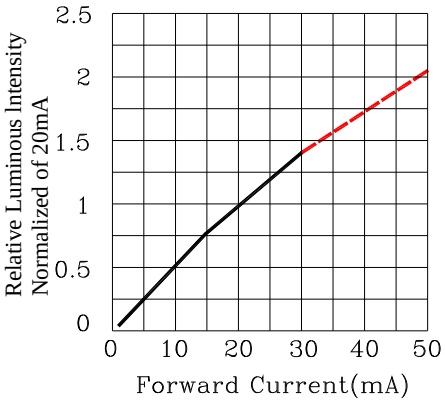

Fig.4 Relative Luminous Intensity vs.Forward Current

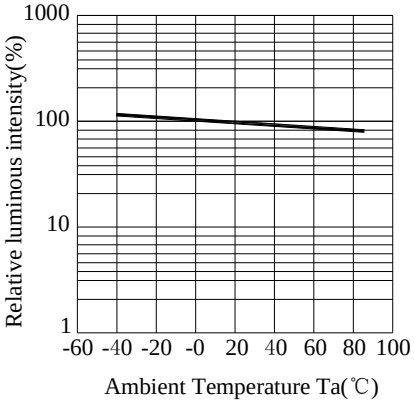

Fig.5 Luminous Intensity vs.Ambient Temperature

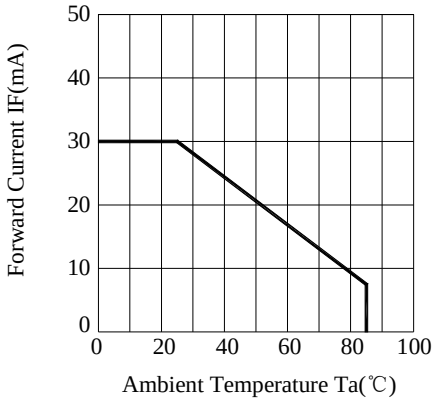

Fig.6 Forward Current Derating Curve

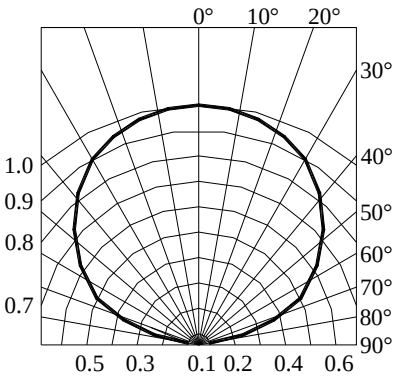

Fig.7 Relative Intensity vs.Angle

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● Super Green Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

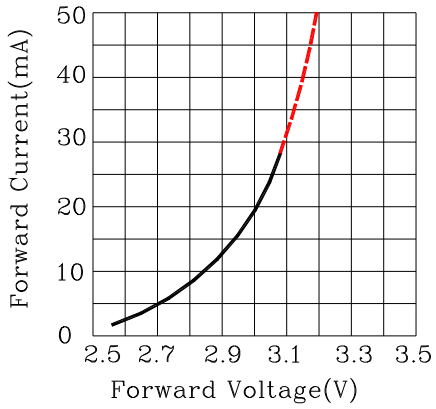

Fig.2 Forward Current vs.Forward Voltage

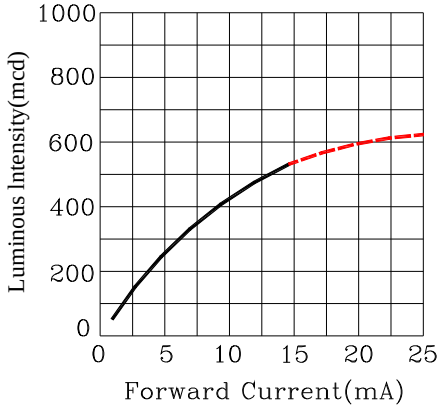

Fig.3 Luminous Intensity vs.Forward Current

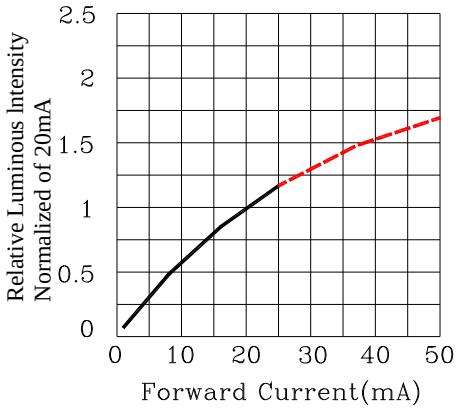

Fig.4 Relative Luminous Intensity vs.Forward Current

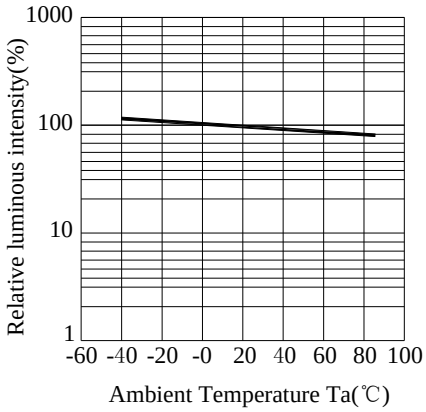

Fig.5 Luminous Intensity vs.Ambient Temperature

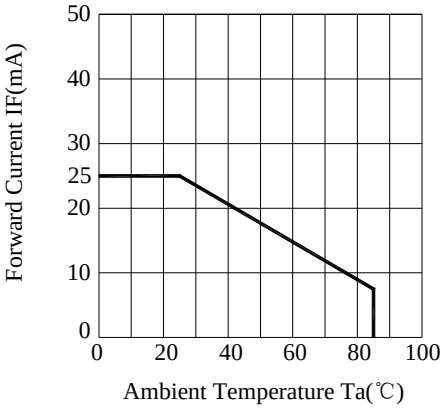

Fig.6 Forward Current Derating Curve

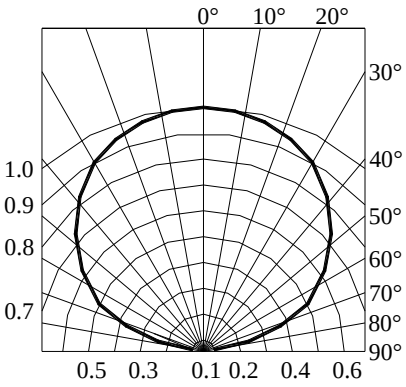

Fig.7 Relative Intensity vs.Angle

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Label Explanation

ITEM CODE:PARA LIGHT

PART NO:L-C295QRLGCT-BIC-5A

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110
A B C D E F

A---EM: Emos Code

B---S:SMD

C---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150、170、110、155、115 series

4000pcs for 191 series

5000pcs for 192 series

DATE CODE：2012 09 10
G H I

G--- Year

H--- Month

I --- Day

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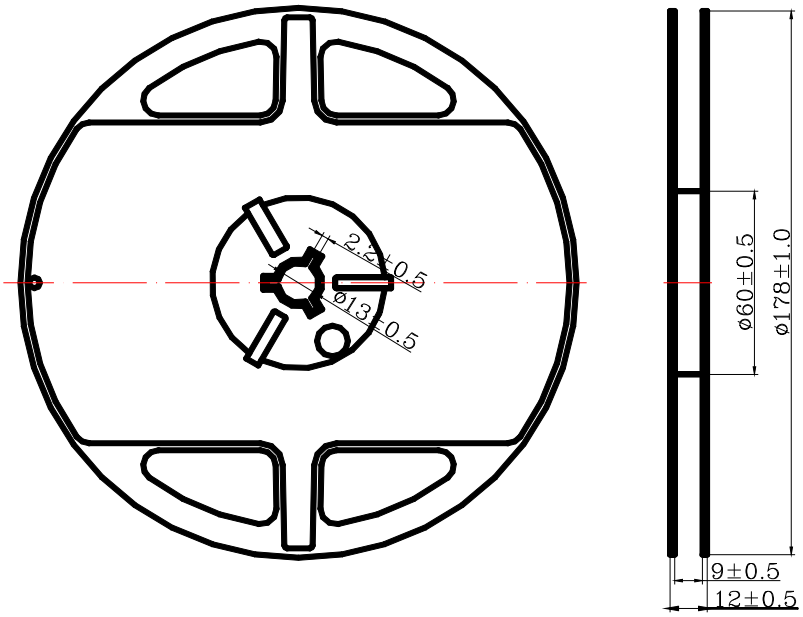
- Reel Dimensions



Notes:

1. Taping Quantity: 4000pcs
2. The tolerances unless mentioned is±0.1mm, Angle±0.5°, Unit: mm.

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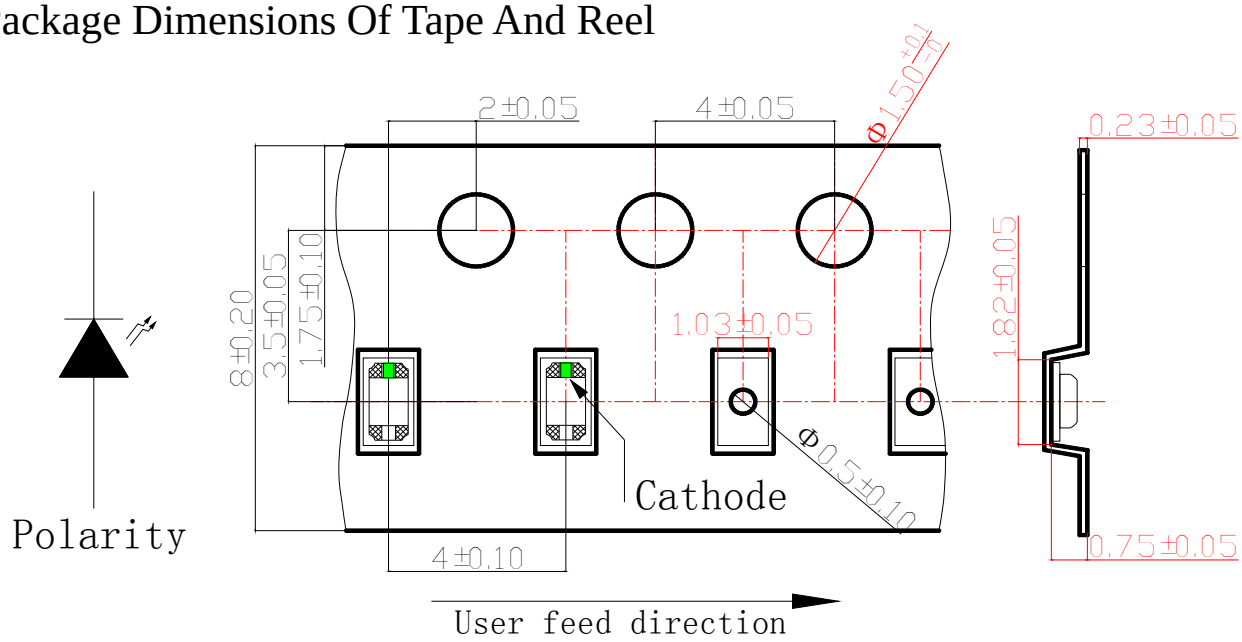
- Package Dimensions Of Tape And Reel

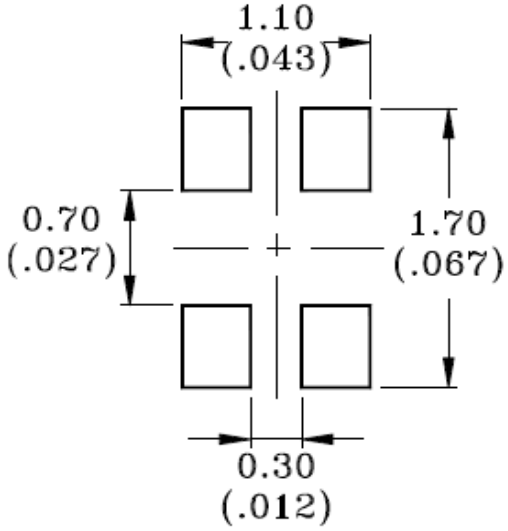


Notes: All dimensions are in millimeters.

- Cleaning

  ∗ If cleaning is required , use the following solutions for less than 1 minute and less than 40℃.
  ∗ Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
  ∗ Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

- Suggest Soldering Pad Dimensions



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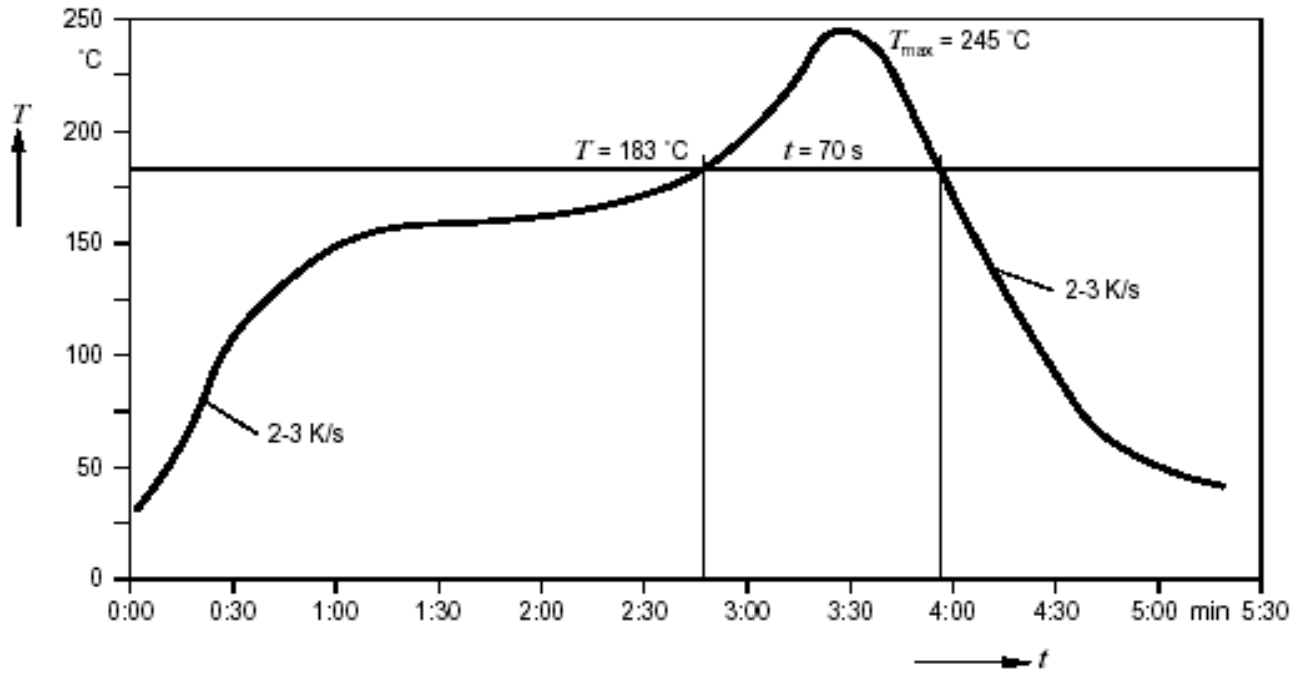
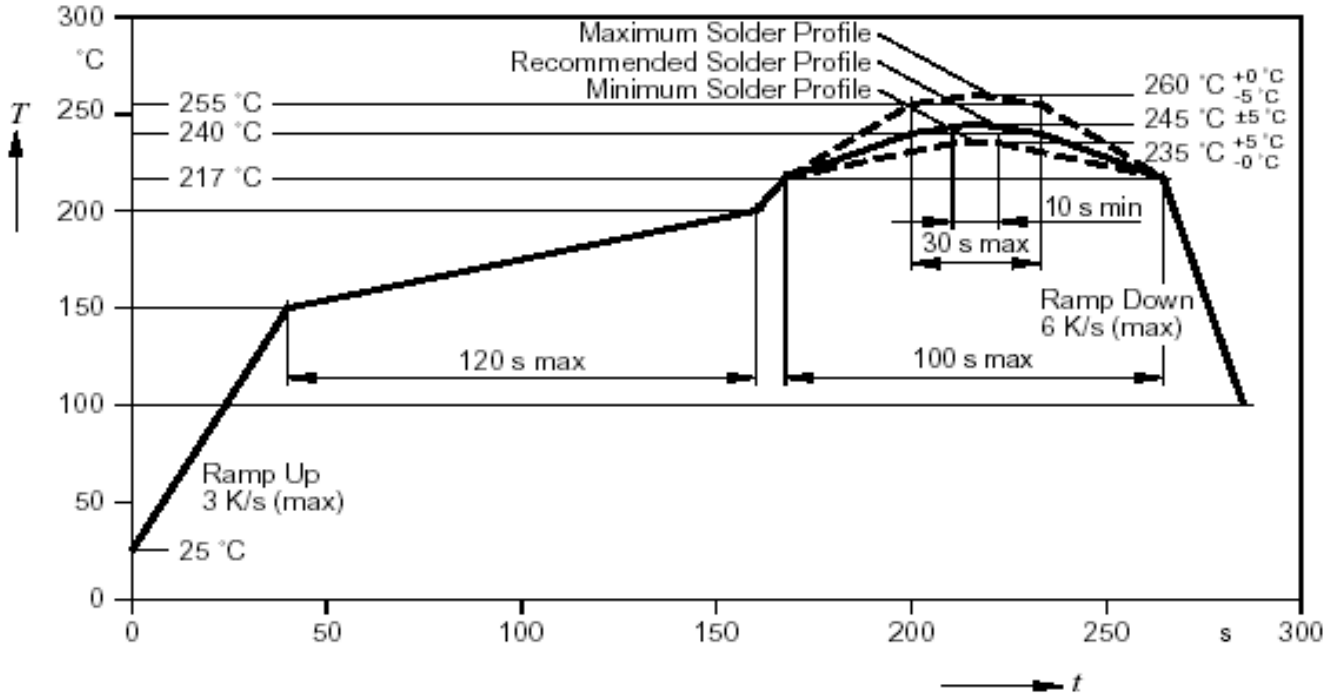
- Suggest Sn/Pb IR Reflow Soldering Profile Condition:



- Suggest Pb-Free IR Reflow Soldering Profile Condition:



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● CAUTIONS

1.Application Limitation:

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30℃ or less and 90%RH or less.

After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5℃ for 24 hours..

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time: 10 sec Max.

Soldering Iron: (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering:

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1st and 2nd soldering processes.

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4. Lead-Free Soldering

For Reflow Soldering:

1、Pre-Heat Temp:150-180℃,120sec.Max.

2、Soldering Temp: Temperature Of Soldering Pot Over 230℃,40sec.Max.

3、Peak Temperature:260℃ ，5sec.

4、Reflow Repetition:3 Times Max.

5、Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

For Soldering Iron (Not Recommended):

1、Iron Tip Temp:350℃ Max.

2、Soldering Iron:30w Max.

3、Soldering Time:3 Sec. Max. One Time.

For Dip Soldering:

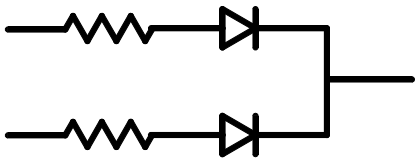
1、Pre-Heat Temp:150℃ Max. 120 Sec. Max.

2、Bath Temp:265℃ Max.

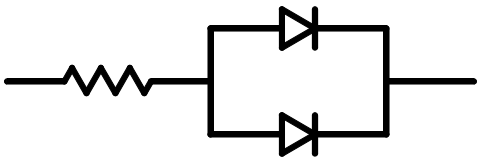
3、Dip Time:5 Sec. Max.

5. Drive Method

Circuit model A



Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.

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履 历 表

文件编号		DS-76-17-015	文件名称	L-C295QRLGCT-BIC-5A	页次：1	
版次	修改日期	变 更 内 容 说 明			生效日期	核准人
A/0	2017.12.15	新建			2017.12.16	朱佳玲
A/1	2019.4.18	更新 taping 图			2019.4.19	朱佳玲